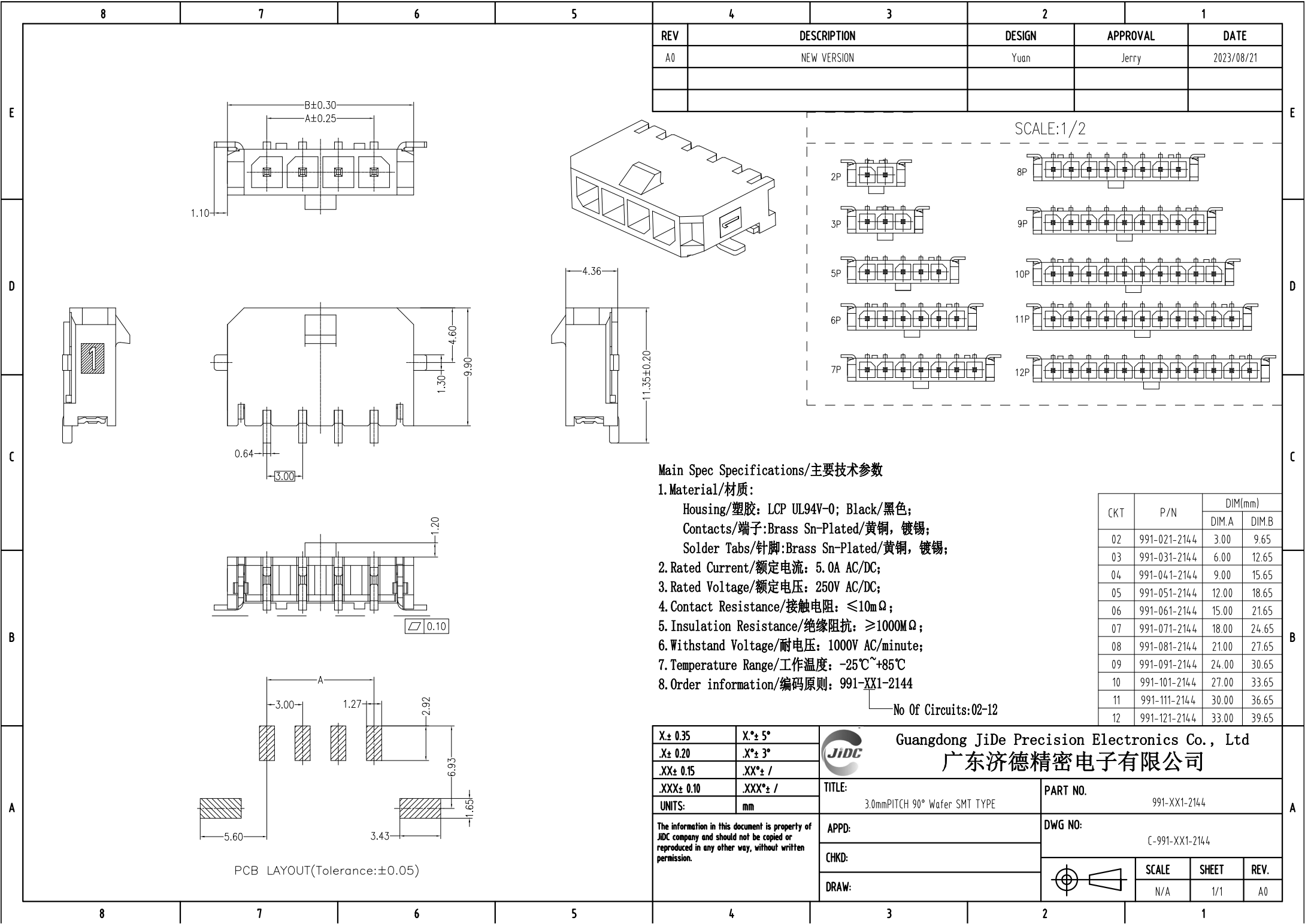
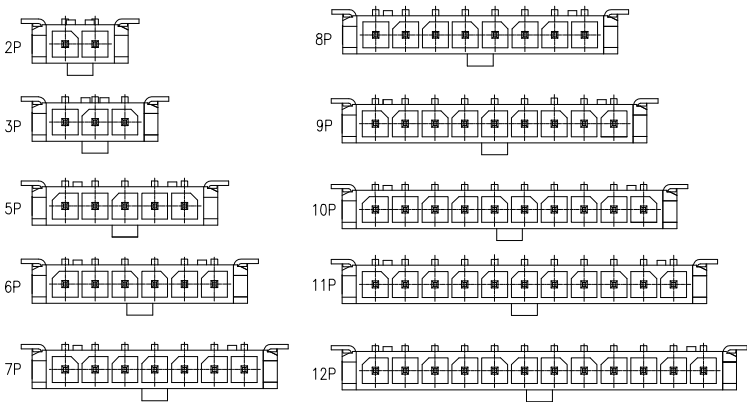




REV	DESCRIPTION	DESIGN	APPROVAL	DATE
A0	NEW VERSION	Yuan	Jerry	2023/08/21

SCALE:1/2



Main Spec Specifications/主要技术参数

1.Material/材质:

Housing/塑胶: LCP UL94V-0; Black/黑色;
Contacts/端子:Brass Sn-Plated/黄铜, 镀锡;
Solder Tabs/针脚:Brass Sn-Plated/黄铜, 镀锡;

2. Rated Current/额定电流: 5.0A AC/DC;

3. Rated Voltage/额定电压: 250V AC/DC;

4. Contact Resistance/接触电阻: $\leq 10m\Omega$;

5. Insulation Resistance/绝缘阻抗: $\geq 1000M\Omega$;

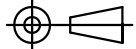
6. Withstand Voltage/耐电压: 1000V AC/minute;

7. Temperature Range/工作温度: $-25^{\circ}C \sim +85^{\circ}C$

8. Order information/编码原则: 991-XX1-2144

No Of Circuits:02-12

CKT	P/N	DIM(mm)	
		DIM.A	DIM.B
02	991-021-2144	3.00	9.65
03	991-031-2144	6.00	12.65
04	991-041-2144	9.00	15.65
05	991-051-2144	12.00	18.65
06	991-061-2144	15.00	21.65
07	991-071-2144	18.00	24.65
08	991-081-2144	21.00	27.65
09	991-091-2144	24.00	30.65
10	991-101-2144	27.00	33.65
11	991-111-2144	30.00	36.65
12	991-121-2144	33.00	39.65

X± 0.35	X°± 5°		Guangdong JiDe Precision Electronics Co., Ltd					
.X± 0.20	.X°± 3°		广东济德精密电子有限公司					
.XX± 0.15	.XX°± /							
.XXX± 0.10	.XXX°± /							
UNITS:	mm	TITLE: 3.0mmPITCH 90° Wafer SMT TYPE		PART NO. 991-XX1-2144				
The information in this document is property of JiDe company and should not be copied or reproduced in any other way, without written permission.		APPD:		DWG NO: C-991-XX1-2144				
		CHKD:						
		DRAW:						
						SCALE	SHEET	REV.
						N/A	1/1	A0